



Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: G0003-03 Product Affected: All Products in 32 pins and 44 pins TSOP Type II packages (PH32 & PH44) Manufacturing Location Affected: All Date Effective: June 20, 2000	MEANS OF DISTINGUISHING CHANGED DEVICES: ☐ Product Mark ☐ Back Mark ☐ Date Code ☒ Other Shipping material
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Contact: PS Tow Title: Director, Corporate Quality / Reliability Phone #: (408) 492-8206 Fax #: (408) 727-2328 E-mail: pstow@idt.com	Additional Data: N/A Samples: N/A
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DESCRIPTION AND PURPOSE OF CHANGE:

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| ☐ Die Technology
☐ Wafer Fabrication Process
☐ Assembly Process
☐ Equipment
☒ Material
☐ Testing
☐ Manufacturing Site
☐ Data Sheet | IDT currently ships all TSOP Type II Packages in either Tape & Reel or Tray.
This PCN only affects products shipped in tray.
With reference to the Date Effective stated above, all TSOP Type II Packages will be shipped in "TUBE" instead of "TRAY" |
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RELIABILITY/QUALIFICATION SUMMARY: N/A

CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.

Customer: _____	☐ <i>Approval for shipments prior to effective date.</i>
Name/Date: _____	E-Mail Address: _____
Title: _____	Phone# /Fax# : _____

CUSTOMER COMMENTS: _____

RECD. BY: _____ DATE: _____